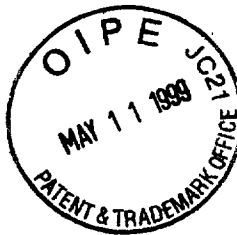


05-26-1999



Docket No. TAYO0003

101045263

Form 1595
1-31-92

RECORDATION FORM

Patent and Trademark Office

U. S. Department of Commerce

PATENTS ONLY

To the Honorable Assistant Commissioner for Patents: Please record the attached
Original documents or copy thereof.

1. Name of conveying party(ies):

HIROSHI CHINO

2. Name/address of receiving
Party(ies)A.K. TECHNICAL LABORATORY,
INC.3. Nature of conveyance: ☒ Assignment☐ Merger ☐ Security Agreement ☐ Other☐ Change of Name ☐ Reassignment4963-3, OHAZAMINAMIJO, SAKAKIMACHI,
HANISHINA-GUN, NAGANO-KEN, JAPAN

4. Date(s) of execution: April 21, 1999

Add'l names of receiving parties
Attached? ☐ Yes ☒ No

5. Application number(s) or patent number(s): 09254788

If this document is being filed together with a new application, the execution
date of the application is April 21, 1999

A. Patent Application No. (s)

09/254,788

B. Patent No.(s)

Additional numbers attached

? ☐ Yes ☒ No6. Name and address of party to whom
correspondence concerning document
should be mailed:

J. C. Patents, Inc.
1340 Reynolds Ave., Suite 114
Irvine, CA 92614
(949) 660-0761

7. Total No. of applications and patents
involved:

ONE(1)

8. Total fee(37CFR § 3.41): \$40.00

☒ Enclosed☐ Charge to Acct. No.9. Total number of pages, including
Cover sheet, attachments and
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To the best of my knowledge and belief, the forging information is true and
Correct and any attached copy is a true copy of the original document.

Jiawei Huang

Name of person Signing
Registration No. 43,330

Signature

Date

05/19/1999 PVOLPE

02 FC:581

PATENT

REEL: 009967 FRAME: 0031

ASSIGNMENT

WHEREAS, the inventors: HIROSHI CHINO

hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **A HERMETIC SEAL AND A WIDE-MOUTHED BOTTLE SEALED BY THE SEAL**

[] Filed: Serial No.:

[x] Executed concurrently with the execution of this instrument

AND WHEREAS, **A.K. TECHNICAL LABORATORY, INC.** (hereinafter "ASSIGNEE"),
residing at

**4963-3, OHAZAMINAMIJO
SAKAKIMACHI, HANISHINA-GUN
NAGANO-KEN, JAPAN**

desires to acquire the entire right, title, and interest in and to the said improvements and the said Application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) each to us in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, we, the said inventors, do hereby acknowledge that we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its/his successors, legal representatives and assigns, the entire right, title, and interest for the territory of the United States of America in, to and under the said improvements, and the said application and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and we hereby authorize and request the Commissioner of Patents of the United States to issue all Letters Patent for said improvements to the said ASSIGNEE, its/his successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant and agree that we will communicate to the said ASSIGNEE, its/his successors, legal representatives and assigns, any facts known to us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its/his successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/their name(s) on the date(s) indicated.

Sole or first inventor's signature:  Date: April 21, 1999

Second inventor's signature: _____ Date: _____

Third inventor's signature: _____ Date: _____

Fourth inventor's signature: _____ Date: _____

Fifth inventor's signature: _____ Date: _____